



# Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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## Supplier Information

Company Name *	Company Unique ID	Unique ID Authority	Response Date *	Response Document ID				
Mindspeed Technologies Inc	N/A	N/A	2012-12-14					
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *					
Cynthia Ong	Program Manager	949-579-5515	cynthia.ong@mindspeed.com					
Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *	Supplier Comments or URL for Additional Information				
Amy Teng	Quality Engineer	604-6328114	amy.teng@mindspeed.com					
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
M02046G-24	M02046G-24	4.95x3.9 QSOP 16	2008-01-31	D	Unisem, Malaysia	80.4473	mg	EACH
Alternate Recommendation		NA		Alternate Item Comments	NA			

## Manufacturing Process Information

Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles
Pure Tin	Cu Alloy	2	260 C	40 seconds	3
Comments					
N/A					

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Import Data

Locked

## RoHS Material Composition Declaration

Declaration Type \*

Simplified

**RoHS Directive 2002/95/EC** **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

**RoHS Declaration \*** 1 - Item(s) does not contain RoHS restricted substances per the definition above

**Supplier Acceptance \*** Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name	Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
											-	+	
M02046G-24	Tin Plate	1.4788	mg	C	GROUP-C	Sn	7440-31-5		1.478830	mg			1,000,0
	Wire	0.5	mg	C	GROUP-C	Au	7440-57-5		0.49995	mg			999,89
	Die Attach	0.1878	mg	C	GROUP-C	Epoxy Resin	68475-94-5		0.009388	mg			49,990
				C	GROUP-C	Lactone	96-48-0		0.009388	mg			49,990
				C	GROUP-C	2,6-Diglycidyl phenyl all	Proprietary		0.009388	mg			49,990
				C	GROUP-C	Epichlorohydrin-formal	9003-36-5		0.009388	mg			49,990
				C	GROUP-C	Silver	7440-22-4		0.140824	mg			749,86
				C	GROUP-C	Polyoxypropylenediami	9046-10-0		0.009388	mg			49,990
	Mold compound	48.5	mg	C	GROUP-C	Phenol Resin	Trade secret		2.425	mg			49,999
				C	GROUP-C	Silica Fused	60676-86-0		42.0495	mg			866,99
				C	GROUP-C	Epoxy Resin	Trade secret		2.91	mg			59,999
				C	GROUP-C	Carbon Black	1333-86-4		0.1455	mg			2,999.9
				C	GROUP-C	Epoxy, Cresol Novolac	29690-82-2		0.97	mg			19,999
	Leadframe	28.2875	mg	C	GROUP-C	P	7723-14-0		0.008383	mg			296.36
				C	GROUP-C	Ag	7440-22-4		0.342941	mg			12,123
				C	GROUP-C	Cu	7440-50-8		27.24594	mg			963,17
				C	GROUP-C	Zn	7440-66-6		0.033533	mg			1,185.4
				C	GROUP-C	Fe	7439-89-6		0.656697	mg			23,215
	Die	1.4932	mg	C	GROUP-C	Silicon Die	7440-21-3		1.4932	mg			999,99